IPC ASSOCIATION CON	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.			This docu- level parts	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information				
Supplier In	formation	,													
Company name*			Company unique ID			Unique ID Authority					Response Date*				
nsemi							I					2024-05-09			
Contact Name	2		Title - Contact			Phone - Contact*				Email - Contact*					
Product-Env-	-Stewards		Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com					
uthorized Re	epresentative*		Title - Representative			Phone - Representative*				Email - Representative*					
Product-Env-	-Stewards		Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com					
Re	Requester Item Number M		Afr Item Number Mfr Item Name			Effective I	Date '	Version Manufacturing Site		V	Weight*	UOM	Unit Type		
		NB7NPQ1004MMTT 3.3 V WG / Dual		3.3 V USB 3.1 Get / Dual Port Linear	.3 V USB 3.1 Gen-2 10Gbps Quad Channel Dual Port Linear Redriver		9		PHG		8	38.73	mg	Each	
Ianufactu	ring Proccess Informa	ation													
Ter	Terminal Plating / Grid Array Material Term			erminal Base Alloy J-STD-020 MSL Rating		Peak Process Body Temperature   Max Time at Pea			Time at Peak	k Temperature Number of Reflow Cycles					
Matte Tin (Sn) - annealed			CU Alloy 1			260	260 C 30			secon	ds 3				
omments															
vel 1 - maxin	num time at peak temperat	ure during sol	dering is 10-3	0 seconds											
or more info	rmation regarding material	l composition	please refer to	page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier have provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.48	mg	Supplier	Silicon (Si)	7440-21-3		1.48	mg
Die Attach	0.35	mg	Supplier	Isobornyl Methacrylate	7534-94-3		0.021	mg
			Supplier	Silver (Ag)	7440-22-4		0.2853	mg
			Supplier	Isobornyl Acrylate	5888-33-5		0.021	mg
			Supplier	Misc.	Proprietary Data		0.0017	mg
			Supplier	Tricyclo[5.2.1.02,6]decanedimethanol Diacrylate (C18H24O4)	42594-17-2		0.021	mg
Lead Frame	30.52	mg	Supplier	Silver (Ag)	7440-22-4		0.6104	mg
			Supplier	Iron (Fe)	7439-89-6		0.6714	mg
			Supplier	Copper (Cu)	7440-50-8		29.2382	mg
Mold Compound-Black	54.16			Epoxy resin	proprietary data		2.708	mg
			Supplier	Phenolic Resin	Proprietary Data		1.2457	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		2.708	mg
			Supplier	Carbon Black (C)	1333-86-4		0.2166	mg
			Supplier	Aluminum Hydroxide (Al(OH)3)	21645-51-2		1.2457	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		46.036	mg
Plating	2.0	mg	Supplier	Tin (Sn)	7440-31-5		2	mg
Wire Bond	0.22		Supplier	Palladium (Pd)	7440-05-3		0.0044	mg
			Supplier	Gold (Au)	7440-57-5		0.0011	mg
			Supplier	Copper (Cu)	7440-50-8		0.2145	mg